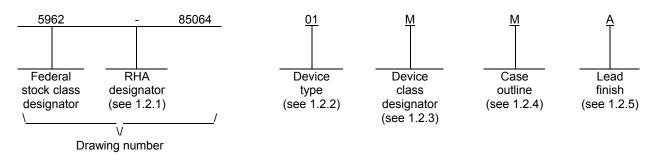
										ONS										
LTR		DESCRIPTION											DATE (YR-MO-DA)		DA)	APPROVED)		
D	Add	device	types C)3 and (04. Ad	d test o	circuit.	Editori	al chan	ges thr	oughou	ut	90-03-05			W. Heckman				
E	Char	nge 1.3	. Conv	ert to o	ne par	t-one p	art nun	nber fo	rmat.				91-02-08			W. Heckman				
F	Char	Changes in accordance with NOR 5962-R323-92											92-0)9-26		Mon	ica L. F	Poelkin	g	
G		Changes in accordance with NOR 5962-R052-93										92-1	2-18			ica L. F				
Н	Add	Add device types 05-08. Add packages M, U, and V. Add class N designate Editorial changes throughout.								ator.)8-23			ica L. F				
J	Upda	Update boilerplate to MIL-PRF-38535 requirements LTG										02-1	2-18		Thor	nas M.	Hess			
к	Upda	ate boile	erplate	to curre	ent MIL	-PRF-	38535	require	ments.	- CFS				07-1	1-26		Thor	nas M.	Hess	
REV SHEET																				
SHEET REV	K 15	K 16	K 17	K 19	K 10	K 20	К К 21	K	К К 23											
SHEET	15	К 16	К 17	К 18 REv	19	К 20	К 21 К	К 22 К	К 23 К	ĸ	ĸ	K	ĸ	ĸ	ĸ	К	К	К	ĸ	к
SHEET REV SHEET	15 S			18	19 ,		21	22	23	К 4	К 5	К 6	К 7	К К 8	К 9	К К 10	К К 11	К К 12	К К 13	К К 14
SHEET REV SHEET REV STATUS	15 S			18 REV SHE	19 ,	20 D BY	21 K	22 K 2	23 K		5		7	8	9	10	11	12	13	
SHEET REV SHEET REV STATUS OF SHEETS PMIC N/A STA MICR	15 S	16 RD CUIT		18 REV SHE PRE	19 ET PAREE	20 D BY Greg J BY	21 K 1	22 K 2	23 K		5	6 EFEN	7 SE SI	8 UPPL	9	10 NTER 0 432	11 218-39	12 .UMB	13	
SHEET REV SHEET REV STATUS OF SHEETS PMIC N/A STA MICR DR THIS DRAW FOR	ANDAF OCIRC AWIN	16 RD CUIT G VAILAI	17	18 REV SHE PREI	19 ET PAREE CKED	20 D BY Greg J BY Wm J. J	21 K 1 A. Pitz	22 K 2	23 K	4 MIC	5 DI	6 EFEN	7 SE SI DLUM http	8 UPPL IBUS p://ww	9 .Y CE , OHIO /w.ds	NTER D 432 cc.dl	11 218-33 a.mil	12 .UMB 990	13 US	
SHEET REV SHEET REV STATUS OF SHEETS PMIC N/A STA MICR DR THIS DRAW FOR	15 S ANDAF OCIRC AWIN USE BY ARTMEN ENCIES (16 RD CUIT G VAILAI ALL ITS DF THE	17 BLE	18 REV SHE PREI	19 ET PARED CKED	20 D BY Greg J BY Mm J. A D BY Michael	21 K 1 A. Pitz Johnso	22 K 2 n	23 K	4 MIC CO	5 DI ROC	6 EFEN CC	7 SE SI DLUM http JIT, [RIEN	8 IBUS; DIGIT	9 .Y CE , OHI0 /w.ds ⁻ AL, (MIC	10 NTER 0 432 cc.dl	11 218-39 a.mil S 8-E OMP	12 .UMB 990	13 US	
SHEET REV SHEET REV STATUS OF SHEETS PMIC N/A MICR DR THIS DRAW FOR DEP/ AND AGE DEPARTME	15 S ANDAF OCIRC AWIN USE BY ARTMEN ENCIES (16 RD CUIT G VAILAI ALL ITS DF THE DEFEN	17 BLE	18 REV SHE PREI CHE	19 FET PAREL CKED	20 D BY Greg J BY Mm J. , D BY Michae APPR(86-(86-(LEVEL	21 K A. Pitz Johnso I A. Fry DVAL D 02-14	22 K 2 n	23 K	4 MIC COI MIC	5 DI ROC	6 EFEN CC CIRCU DL-O CONT	7 SE SI DLUM http JIT, [RIEN	8 IBUS DIGIT ITED LER,	9 .Y CE , OHI0 /w.ds ⁻ AL, (MIC	10 NTER 0 432 cc.dl	11 218-3: a.mil S 8-E OMP THIC	12 .UMB 990	13 US	

1. SCOPE

1.1 <u>Scope</u>. This drawing documents three product assurance class levels consisting of space application (device class V), high reliability (device classes M and Q),and nontraditional performance environment (device class N). A choice of case outlines and lead finishes are available and are reflected in the Part or Identifying Number (PIN). When available, a choice of Radiation Hardness Assurance (RHA) levels is reflected in the PIN. For device class N, the user is cautioned to assure that the device is appropriate for the application environment.

1.2 <u>PIN</u>. The PIN is as shown in the following example:



1.2.1 <u>RHA designator</u>. Device classes N, Q, and V RHA marked devices meet the MIL-PRF-38535 specified RHA levels and are marked with the appropriate RHA designator. Device class M RHA marked devices meet the MIL-PRF-38535, appendix A specified RHA levels and are marked with the appropriate RHA designator. A dash (-) indicates a non-RHA device.

1.2.2 <u>Device type(s)</u>. The device type(s) identify the circuit function as follows:

Device type	Generic number	Circuit function
01 02	80C31BH 80C51BH	8-bit microcontroller (3.5 to 12 MHz) 8-bit microcontroller with a mask programmable ROM (3.5 to 12 MHz)
03 04	80C31BH-16 80C51BH-16	8-bit microcontroller (3.5 to 16 MHz) 8-bit microcontroller with a mask programmable ROM (3.5 to 16 MHz)
05 06	80C31BH 80C51BH	8-bit microcontroller (3.5 to 12 MHz) 8-bit microcontroller with a mask programmable ROM (3.5 to 12 MHz)
07 08	80C31BH-16 80C51BH-16	8-bit microcontroller (3.5 to 16 MHz) 8-bit microcontroller with a mask programmable ROM (3.5 to 16 MHz)

1.2.3 <u>Device class designator</u>. The device class designator is a single letter identifying the product assurance level as follows:

Device class	Device requirements documentation
Μ	Vendor self-certification to the requirements for MIL-STD-883 compliant, non- JAN class level B microcircuits in accordance with MIL-PRF-38535, appendix A
Ν	Certification and qualification to MIL-PRF-38535 with a nontraditional performance environment (encapsulated in plastic)
Q or V	Certification and qualification to MIL-PRF-38535

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1.2.4 <u>Case outline(s)</u>. The case outline(s) are as designated in MIL-STD-1835, JEDEC Publication 95, and as follows:

Outline letter	Descriptive designator	Terminals	Package style	Document
М	GQCC1-J44	44	"J" leaded chip carrier	MIL-STD-1835
Q	GDIP1-T40 or CDIP2-T40	40	Dual-in-line	MIL-STD-1835
U	MS-011-AC	40	Plastic dual-in-line	JEP 95
V	MS-018-AC	44	Plastic "J" leaded chip carrier	JEP 95
Х	CQCC1-N44	44	Square chip carrier	MIL-STD-1835
Y	See figure 1	52	Flat pack	MIL-STD-1835

1.2.5 <u>Lead finish</u>. The lead finish is as specified in MIL-PRF-38535 for device classes N, Q, and V or MIL-PRF-38535, appendix A for device class M.

1.3 Absolute maximum ratings. 1/

Supply voltage range (referenced to ground) Maximum power dissipation (P_D)	
Voltage (any pin) to V _{ss}	
Storage temperature range (T _{STG})	
Maximum junction temperature (T _J)	+200°C
Lead temperature (soldering 5 seconds) (T _S)	+300°C
Thermal resistance junction-to-case (θ_{JC}):	
Case M, Q, and X	See MIL-STD-1835
Case Y	20°C/W
Case U	15°C/W
Case V	14°C/W

1.4 Recommended operating conditions.

Operating supply voltage range (V _{CC})	
Maximum low level input voltage (except EA)	
(EA)	0.2V _{CC} - 0.45 V dc
Maximum high level input voltage (except XTAL1, RST)	0.2V _{CC} + 1.1 V dc
(XTA1, RST)	0.7V _{CC} + 0.2 V dc
Case operating temperature range (T _C):	
Device types 01, 02, 03, and 04	55°C to +125°C
Device types 05, 06, 07, and 08	40°C to +85°C
Oscillator frequency:	
Device types 01, 02, 05, and 06	3.5 MHz to 12 MHz
Device types 03, 04, 07, and 08	3.5 MHz to 16 MHz

1/ Stresses above the absolute maximum rating may cause permanent damage to the device. Extended operation at the maximum levels may degrade performance and affect reliability.

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2. APPLICABLE DOCUMENTS

2.1 <u>Government specification, standards, and handbooks</u>. The following specification, standards, and handbooks form a part of this drawing to the extent specified herein. Unless otherwise specified, the issues of these documents are those cited in the solicitation or contract.

DEPARTMENT OF DEFENSE SPECIFICATION

MIL-PRF-38535 - Integrated Circuits, Manufacturing, General Specification for.

DEPARTMENT OF DEFENSE STANDARDS

MIL-STD-883 -	Test Method Standard	Microcircuits.
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MIL-STD-1835 - Interface Standard Electronic Component Case Outlines.

DEPARTMENT OF DEFENSE HANDBOOKS

MIL-HDBK-103	-	List of Standard Microcircuit Drawings.
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MIL-HDBK-780 - Standard Microcircuit Drawings.

(Copies of these documents are available online at <u>http://assist.daps.dla.mil/quicksearch/</u> or <u>http://assist.daps.dla.mil</u> or from the Standardization Document Order Desk, 700 Robbins Avenue, Building 4D, Philadelphia, PA 19111-5094.)

2.2 <u>Non-Government publications</u>. The following documents form a part of this document to the extent specified herein. Unless otherwise specified, the issues of these documents are those cited in the solicitation or contract.

ELECTRONICS INDUSTRIES ALLIANCE (EIA)

JEP 95 - Registered and Standard Outlines for Semiconductor Devices

(Copies of these documents are available online at <u>www.jedec.org/</u> or from the Electronics Industries Alliance, 2500 Wilson Boulevard, Arlington, VA 22201-3834).

2.3 <u>Order of precedence</u>. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing takes precedence. Nothing in this document, however, supersedes applicable laws and regulations unless a specific exemption has been obtained.

3. REQUIREMENTS

3.1 <u>Item requirements</u>. The individual item requirements for device classes N, Q and V shall be in accordance with MIL-PRF-38535 and as specified herein or as modified in the device manufacturer's Quality Management (QM) plan. The modification in the QM plan shall not affect the form, fit, or function as described herein. The individual item requirements for device class M shall be in accordance with MIL-PRF-38535, appendix A for non-JAN class level B devices and as specified herein.

3.2 <u>Design, construction, and physical dimensions</u>. The design, construction, and physical dimensions shall be as specified in MIL-PRF-38535 and herein for device classes N, Q and V or MIL-PRF-38535, appendix A and herein for device class M.

3.2.1 Case outlines. The case outlines shall be in accordance with 1.2.4 herein and figure 1.

3.2.2 <u>Terminal connections</u>. The terminal connections shall be as specified on figure 2.

3.2.3 <u>Block diagram</u>. The block diagram shall be as specified on figure 3.

3.2.4 <u>Switching waveforms and test circuit</u>. The switching waveforms and test circuit shall be as specified on figure 4.

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3.3 <u>Electrical performance characteristics and postirradiation parameter limits</u>. Unless otherwise specified herein, the electrical performance characteristics and postirradiation parameter limits are as specified in table I and shall apply over the full case operating temperature range.

3.4 <u>Electrical test requirements</u>. The electrical test requirements shall be the subgroups specified in table II. The electrical tests for each subgroup are defined in table I.

3.5 <u>Marking</u>. The part shall be marked with the PIN listed in 1.2 herein. In addition, the manufacturer's PIN may also be marked. For packages where marking of the entire SMD PIN number is not feasible due to space limitations, the manufacturer has the option of not marking the "5962-" on the device. For RHA product using this option, the RHA designator shall still be marked. Marking for device classes N, Q and V shall be in accordance with MIL-PRF-38535. Marking for device class M shall be in accordance with MIL-PRF-38535, appendix A.

3.5.1 <u>Certification/compliance mark</u>. The certification mark for device classes N, Q, and V shall be a "QML" or "Q" as required in MIL-PRF-38535. The compliance mark for device class M shall be a "C" as required in MIL-PRF-38535, appendix A.

3.6 <u>Certificate of compliance</u>. For device classes N, Q, and V, a certificate of compliance shall be required from a QML-38535 listed manufacturer in order to supply to the requirements of this drawing (see 6.6.1 herein). For device class M, a certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in MIL-HDBK-103 (see 6.6.2 herein). The certificate of compliance submitted to DSCC-VA prior to listing as an approved source of supply for this drawing shall affirm that the manufacturer's product meets, for device classes N, Q, and V, the requirements of MIL-PRF-38535 and herein or for device class M, the requirements of MIL-PRF-38535, appendix A and herein.

3.7 <u>Certificate of conformance</u>. A certificate of conformance as required for device classes N, Q, and V in MIL-PRF-38535 or for device class M in MIL-PRF-38535, appendix A shall be provided with each lot of microcircuits delivered to this drawing.

3.8 <u>Notification of change for device class M</u>. For device class M, notification to DSCC-VA of change of product (see 6.2 herein) involving devices acquired to this drawing is required for any change that affects this drawing.

3.9 <u>Verification and review for device class M</u>. For device class M, DSCC, DSCC's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.

3.10 <u>Microcircuit group assignment for device class M</u>. Device class M devices covered by this drawing shall be in microcircuit group number 105 (see MIL-PRF-38535, appendix A).

3.11 <u>User mask program</u>. For device types 02, 04, 06, and 08, since the ROM is memory programmed by the manufacturer in a variety of configurations, the contracting activity shall provide an altered item drawing describing the mask program to be used by the manufacturer.

3.12 <u>PIN supersession information</u>. The PIN supersession information shall be as specified in 6.7 herein.

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		TABLE I. <u>Electrical performan</u>	Ce characteris	<u>ucs</u> .			
Test	Symbol	Conditions <u>1</u> /	Group A	Device	Lim	nits	Unit
		V_{CC} = 5 V ±20% unless otherwise specified	subgroups	type	Min	Max]
Output low voltage (ports 1, 2, 3)	V _{OL}	I _{OL} = 1.6 mA <u>2</u> /	1, 2, 3	All		0.45	V
Output low voltage (port 0, ALE, PSEN)	V _{OL1}	I _{OL} = 3.2 mA <u>2</u> /	1, 2, 3	All		0.45	V
Output high voltage	V _{OH}	I_{OH} = -60 μ A, V _{CC} = 5 V \pm 10%	1, 2, 3	All	2.4		V
(ports 1, 2, 3)		I_{OH} = -25 μ A, V_{CC} = 5 V ±10%			0.75 V _{CC}		
		I_{OH} = -10 μ A, V_{CC} = 5 V ±10%			0.90 V _{CC}		
Output high voltage	V _{OH1}	I_{OH} = -400 μ A, V _{CC} = 5 V \pm 10%	1, 2, 3	All	2.4		V
(port 0 in external		I_{OH} = -150 μ A, V _{CC} = 5 V ±10%			$0.75 V_{CC}$		
bus mode, ALE, PSEN)		I_{OH} = -40 μ A, V _{CC} = 5 V ±10% <u>3</u> /			0.90 V _{CC}		
Logical 0 input current (ports 1, 2, 3)	I _{IL}	V _{IN} = 0.45 V	1, 2, 3	All		-75	μA
Logical 1 to 0 transition current (ports 1, 2, 3)	I _{TL}	V _{IN} = 2 V	1, 2, 3	All		-750	μA
Input leakage current (port 0, EA)	I _{LI}	0.45 < V _{IN} < V _{CC}	1, 2, 3	All		±10	μA
Supply current	I _{CC1}	3.5 MHz, V _{CC} 4 V	1, 2, 3	All		4.3	mA
during operation		3.5 MHz, V _{CC} 5 V <u>5</u> ∕				5.7	
<u>4</u> /		3.5 MHz, V _{CC} 6 V				7.5	
		8.0 MHz, V _{CC} 4 V <u>5</u> /				8.3	
		8.0 MHz, V _{CC} 5 V <u>5</u> /				11	
		8.0 MHz, V _{CC} 6 V <u>5</u> /				14	
		12 MHz, V _{CC} 4 V				12	
		12 MHz, V _{CC} 5 V <u>5</u> /				16	
		12 MHz, V _{CC} 6 V				20	╂────
Supply current	I _{CC2}	16 MHz, V _{CC} 4 V	1, 2, 3	03, 04		16	mA
during operation		16 MHz, V _{CC} 5 V <u>5</u> /		07, 08		21	
		16 MHz, V _{CC} 6 V				25	

TABLE I. Electrical performance characteristics.

See footnotes at end of table.

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Test	Symbol	Conditions <u>1</u> /	Group A	Device	Li	mits	Unit
		V_{CC} = 5 V ±20% unless otherwise specified	subgroups	type	Min	Max	
Supply current	I _{CC3}	3.5 MHz, V _{CC} 4 V	1, 2, 3	All		1.1	mA
during idle mode		3.5 MHz, V _{CC} 5 V <u>5</u> /				1.6	
<u>6</u> /		3.5 MHz, V _{CC} 6 V				2.2	
		8.0 MHz, V _{CC} 4 V <u>5</u> /				1.8	
		8.0 MHz, V _{CC} 5 V <u>5</u> /				2.7	
		8.0 MHz, V _{CC} 6 V <u>5</u> /				3.7	
		12 MHz, V _{CC} 4 V				2.5	
		12 MHz, V _{CC} 5 V <u>5</u> /				3.7	
		12 MHz, V _{CC} 6 V				5.0	
	I _{CC4}	16 MHz, V _{CC} 4 V		03, 04		4.0	
		16 MHz, V _{CC} 5 V <u>5</u> /		07, 08		5.5	
		16 MHz, V _{CC} 6 V				7.0	
Power down current	I _{PD}	V _{CC} = 2 V to 6 V <u>7</u> /	1, 2, 3	All		75	μA
Reset pulldown resistor	R _{RST}		1, 2, 3	All	50	150	kΩ
Pin capacitance	C _{IO}	See 4.4.1c	4	All		10	pF
Functional tests		See 4.4.1d	7, 8	All			
Oscillator	1/t _{CLCL}		9, 10, 11	01, 02	3.5	12	MHz
frequency				05, 06			
				03, 04 07, 08	3.5	16	
ALE pulse width	t _{LHLL}	C_L = 100 pF for port 0, ALE,	9, 10, 11	All	2t _{CLCL} -55		ns
Address valid to	t _{AVLL}	and PSEN			t _{CLCL} -70		
ALE low	<u>8</u> /	C_L = 80 pF for all other					
Address hold after ALE low	t _{LLAX}	outputs (see figure 4)			t _{CLCL} -50		
ALE low to valid instruction in	t _{LLIV}					4t _{CLCL} -115	
ALE low to PSEN low	t _{LLPL}				t _{CLCL} -55		
PSEN pulse width	t _{PLPH}				3t _{CLCL} -60		
PSEN low to valid	t _{PLIV}					3t _{CLCL} -120	1
instruction in							
nput instruction	t _{PXIX}				0		
hold after PSEN							
Input instruction	t _{PXIZ}					t _{CLCL} -120	
float after PSEN							
See footnotes at end c	of table.	1		I			<u> </u>

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TABLE I.	Electrical	performance	characteristics	_	Continued.

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Test	Symbol	Conditions <u>1</u> /	Group A	Device	Lir	nits	Ur
		V_{CC} = 5 V ±20%	subgroups	type	Min	Max	
		unless otherwise specified					_
Address to valid	t _{AVIV}	$C_L = 100 \text{ pF}$ for port 0, ALE, and PSEN	9, 10, 11	All		5t _{CLCL} -120	n
instruction in		$C_L = 80 \text{ pF}$ for all other					-
PSEN low to	t _{PLAZ}	outputs (see figure 4)				25	
address float	4	·			Ct 400		-
RD pulse width	t _{RLRH}				6t _{CLCL} -100		-
WR pulse width	t _{wLWH}				6t _{CLCL} -100		-
RD low to valid data in	t _{RLDV}					5t _{CLCL} -185	
Data hold after RD	t _{RHDX}				0		
Data float after RD	t _{RHDZ}					2t _{CLCL} -85	
ALE low to valid data in	t _{LLDV}					8t _{CLCL} -170	
Address valid to data in	t _{AVDV}					9t _{CLCL} -185	
ALE low to RD or WR low	t _{LLWL}				3t _{CLCL} -65	3t _{CLCL} +65	1
Address to RD or WR low	t _{AVWL}				4t _{CLCL} -145		
Data valid to WR transition	t _{QVWX}				t _{CLCL} -75		
Data holds after WR	t _{WHQX}				t _{CLCL} -65		
RD low to address float	t _{RLAZ}					0	
RD or WR high to high	t _{WHLH}				t _{CLCL} -65	t _{CLCL} +65	
External clock high time	t _{CHCX}				20		
External clock low time	t _{CLCX}				20		
External clock rise time	t _{cLCH} <u>9</u> /					20	1
External clock fall time	t _{CHCL} <u>9</u> /					20	1
Serial port clock cycle time	t _{XLXL} <u>5</u> /				12t _{CLCL}		
See footnotes at e	nd of table.						•
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TABLE I. Electrical performance characteristics - Continued.	
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	TABLE I. <u>Electrical performance characteristics</u> - Continued.							
Test	Symbol	Conditions <u>1</u> /	Group A	Device	Lin	nits	Unit	
		V_{CC} = 5 V ±20% unless otherwise specified	subgroups	type	Min	Max		
Output data setup to clock rising edge	t _{qvxн} <u>5</u> /	$C_L = 100 \text{ pF for port 0,}$ ALE, and PSEN $C_L = 80 \text{ pF for all other}$	9, 10, 11	All	10t _{CLCL} -133		ns	
Output data hold after clock rising edge	t _{хнох} <u>5</u> /	outputs (see figure 4)			2t _{CLCL} -117			
Input data hold after clock rising edge	t _{xHDX} <u>5</u> /				0			
Clock rising edge to input data valid	t _{xHDV} <u>5</u> /					10t _{CLCL} -133		

TABLE I. <u>Electrical performance characteristics</u> - Continued.

1/ Unless otherwise specified, all testing to be performed using worst case conditions. The operating temperature shall be as specified in section 1.4.

- 2/ Capacitive loading on ports 0 and 2 may cause spurious noise pulses to be superimposed on the V_{OL} of ALE and ports 1 and 3. The noise is due to external bus capacitance discharging into the port 0 and port 2 pins when these pins make 1-to-0 transitions during bus operations. In the worst cases (capacitive loading > 100 pF), the noise pulse on the ALE line may exceed 0.8 V. In such cases it may be desirable to qualify ALE with a Schmitt Trigger, or use an address latch with a Schmitt Trigger STROBE input.
- $\underline{3}$ / Capacitive loading on ports 0 and 2 may cause the V_{OH} on ALE and PSEN to momentarily fall below the 0.9 V_{CC} specification when the address bits are stabilizing.
- <u>4</u>/ I_{CC} is measured with all output pins disconnected; XTAL1 driven with t_{CLCH}, t_{CHCL} = 5 ns, V_{IL} = V_{SS} + 0.5 V, I_{CC} would be slightly higher if a crystal oscillator is used.
- 5/ Shall be guaranteed if not tested to the limits specified.
- 6/ Idle I_{CC} is measured with all output pins disconnected; XTAL1 driven with t_{CLCH}, t_{CHCL} = 5 ns, V_{IL} = V_{SS} + 0.5 V, XTAL2 N.C.; Port 0 = V_{CC}; EA = RST = V_{SS}.
- <u>7</u>/ Power down I_{CC} is measured with all output pins disconnected; EA = PORT, 0 = V_{CC} ; XTAL2 N.C.; RST = V_{SS} .
- $\underline{8}$ / When using timing equations, the minimum value shall be not less than 5 ns.
- 9/ Due to test equipment limitations, actual tested values may differ from those specified, but specified limits are guaranteed.

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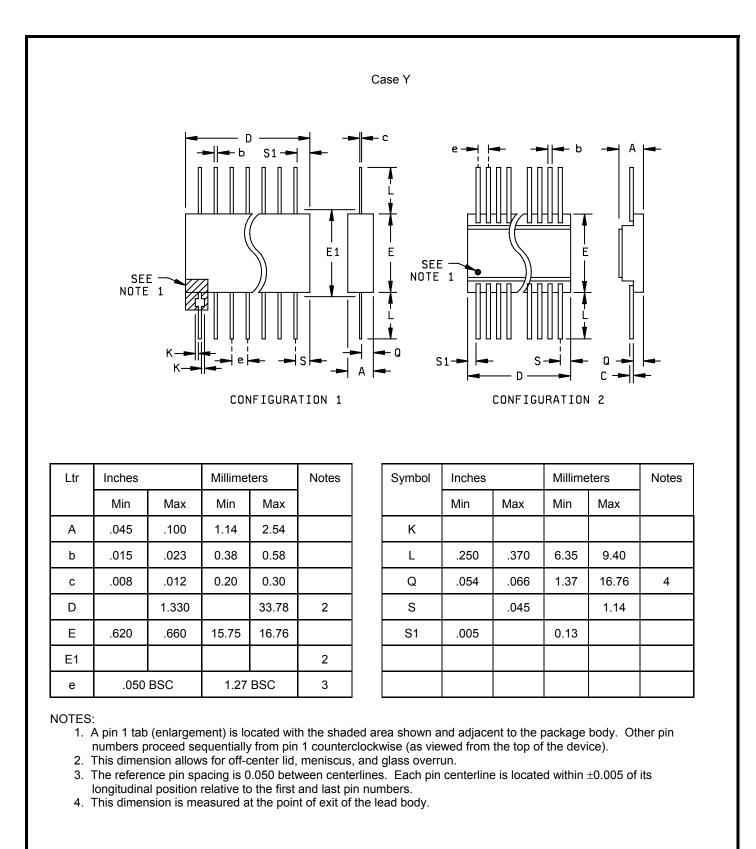


FIGURE 1. Case outlines.

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		REVISION LEVEL K	SHEET 10

	1					
Device type		All				
Case outline	Q and U					
Terminal number	Terminal symbol	Terminal number	Terminal symbol			
1	P1.0	21	P2.0			
2	P1.1	22	P2.1			
3	P1.2	23	P2.2			
4	P1.3	24	P2.3			
5	P1.4	25	P2.4			
6	P1.5	26	P2.5			
7	P1.6	27	P2.6			
8	P1.7	28	P2.7			
9	RESET	29	PSEN			
10	P3.0/RXD	30	ALE			
11	P3.1/TXD	31	EA			
12	P3.2 <u>/INT0</u>	32	P0.7			
13	P3.3/INT1	33	P0.6			
14	P3.4/T0	34	P0.5			
15	P3.5/T1	35	P0.4			
16	P3.6/WR	36	P0.3			
17	P3.7/RD	37	P0.2			
18	XTAL2	38	P0.1			
19	XTAL1	39	P0.0			
20	V _{SS}	40	V _{cc}			

Device type		All	
Case outline		M, X, and V	
Terminal number	Terminal symbol	Terminal number	Terminal symbol
1	NC	23	NC
2	P1.0	24	P2.0
3	P1.1	25	P2.1
4	P1.2	26	P2.2
5	P1.3	27	P2.3
4 5 6 7	P1.4	28	P2.4
	P1.5	29	P2.5
8 9	P1.6	30	P2.6
	P1.7	31	<u>P2.7</u>
10	RESET	32	PSEN
11	P3.0	33	ALE
12	NC	34	<u>NC</u> EA
13	P3.1	35	
14	P3.2	36	P0.7
15	P3.3	37	P0.6
16	P3.4	38	P0.5
17	P3.5	39	P0.4
18	P3.6	40	P0.3
19	P3.7	41	P0.2
20	XTAL2	42	P0.1
21	XTAL1	43	P0.0
22	V _{SS}	44	V _{CC}

NC = No connection

FIGURE 2. Terminal connections.

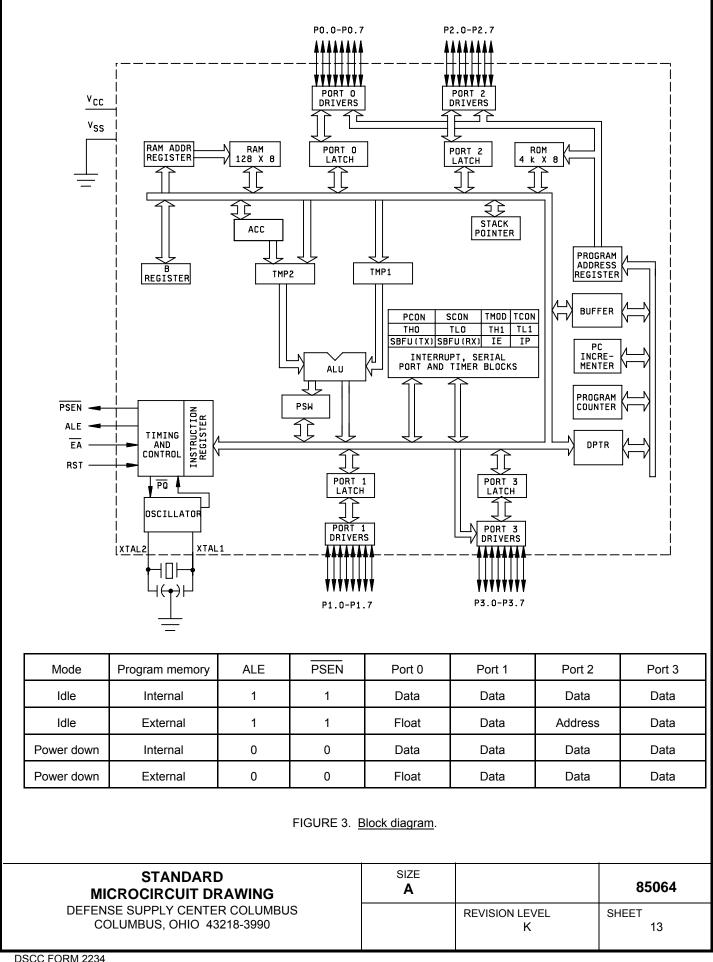
STANDARD MICROCIRCUIT DRAWING	SIZE A		85064
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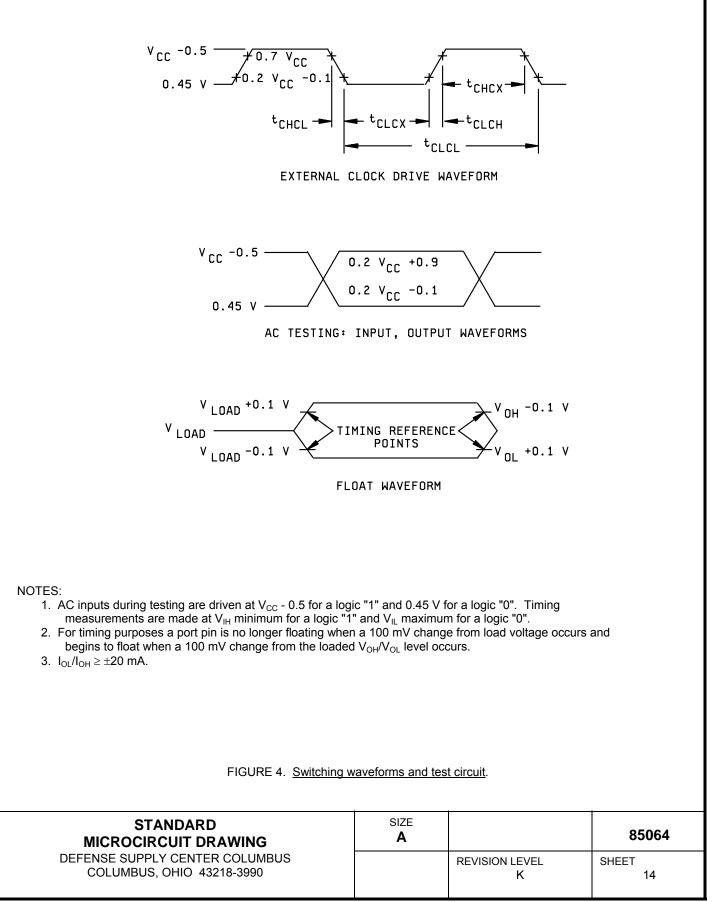
Device type		All	
Case outline		Y	
Terminal number	Terminal symbol	Terminal number	Terminal symbol
1	P1.0	27	P2.0
2	P1.1	28	P2.1
2 3	P1.2	29	P2.2
4	P1.3	30	P2.3
4 5 6	P1.4	31	P2.4
6	NC	32	NC
7	NC	33	NC
8	NC	34	NC
9	NC	35	P2.5
10	P1.5	36	P2.6
11	P1.6	37	<u>P2.7</u>
12	P1.7	38	PSEN
13	RST	39	ALE
14	P3.0/RXD	40	EA
15	P3.1 <u>/TXD</u>	41	P0.7
16	P3.2 <u>/INT0</u>	42	P0.6
17	P3.3/INT1	43	P0.5
18	P3.4/T0	44	P0.4
19	NC	45	NC
20	NC	46	NC
21	P3.5 <u>/T</u> 1	47	NC
22	P3.6/ <u>WR</u>	48	P0.3
23	P3.7/RD	49	P0.2
24	XTAL2	50	P0.1
25	XTAL1	51	P0.0
26	V _{SS}	52	V _{CC}

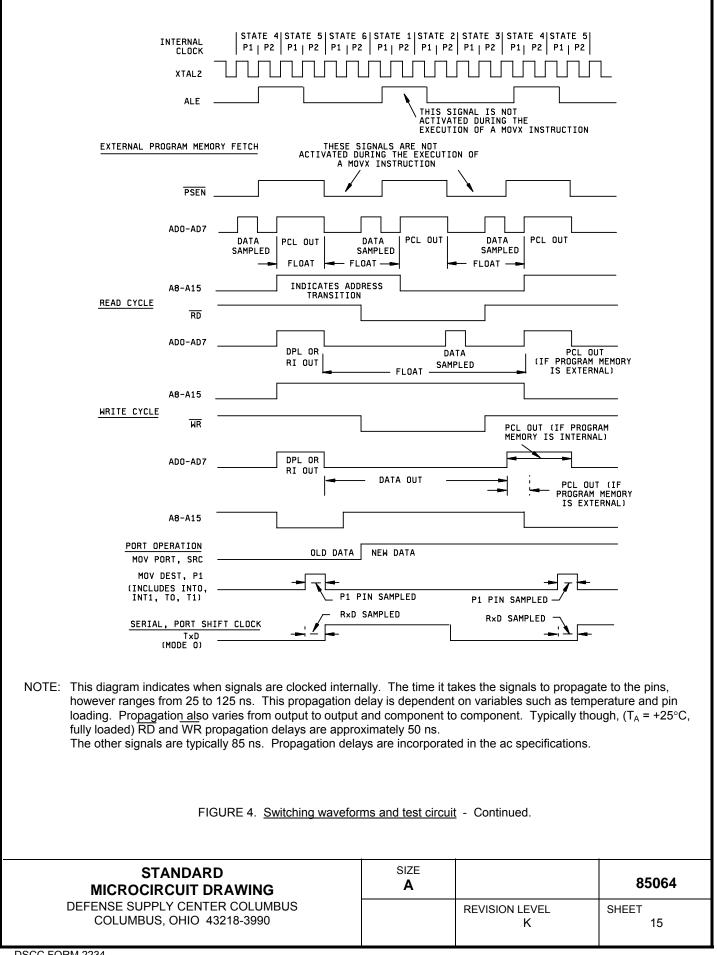
NC = No connection

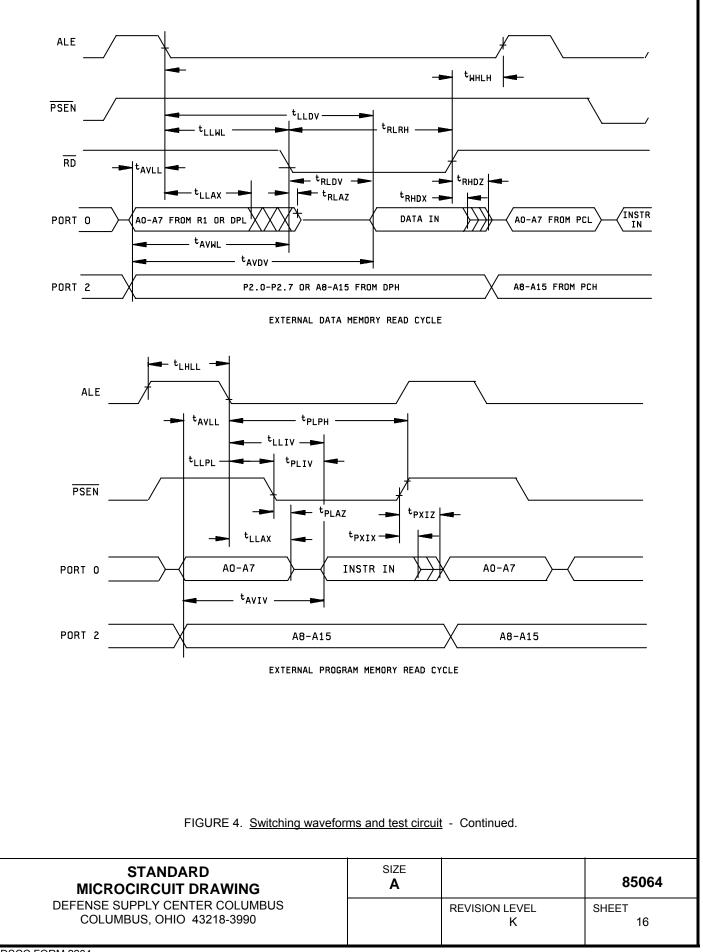
FIGURE 2. <u>Terminal connections</u> – Continued.

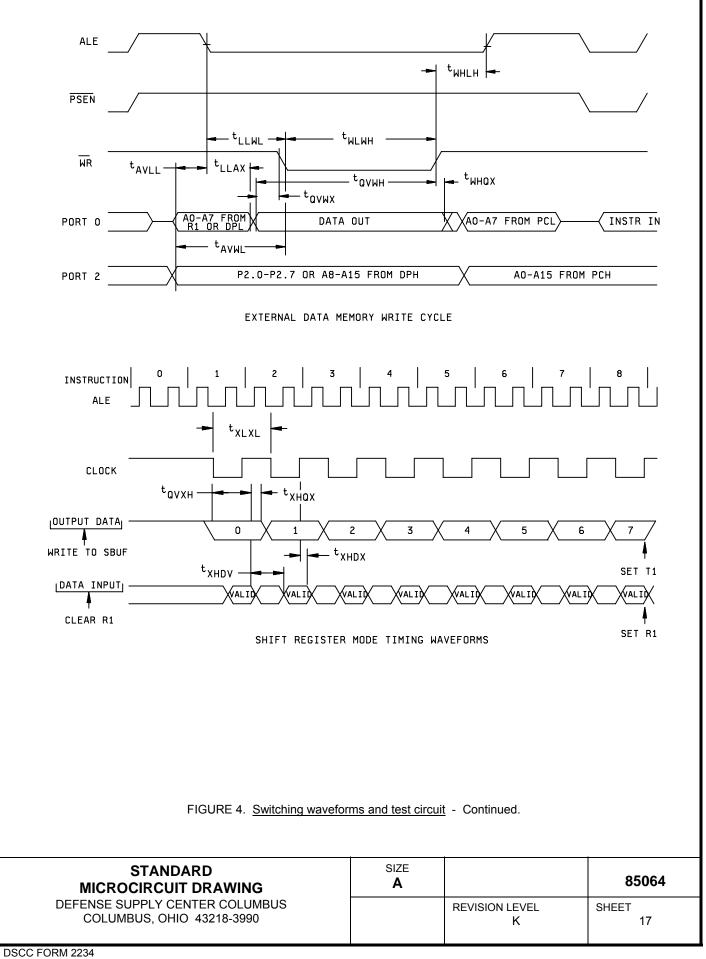
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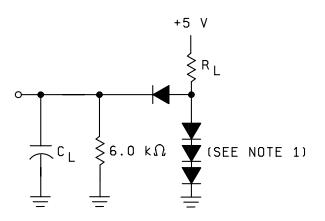












Output	RL	CL
Port 0, ALE, PSEN	1. 2 kΩ	100 pF
All other outputs	2.4 kΩ	80 pF

NOTES:

All diodes are 1N914 or equivalent.
C_L includes tester and fixture capacitance.

FIGURE 4. Switching waveforms and test circuit - Continued.

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4. VERIFICATION

4.1 <u>Sampling and inspection</u>. For device classes N, Q, and V, sampling and inspection procedures shall be in accordance with MIL-PRF-38535 or as modified in the device manufacturer's Quality Management (QM) plan. The modification in the QM plan shall not affect the form, fit, or function as described herein. For device class M, sampling and inspection procedures shall be in accordance with MIL-PRF-38535, appendix A.

4.2 <u>Screening</u>. For device classes N, Q, and V, screening shall be in accordance with MIL-PRF-38535, and shall be conducted on all devices prior to qualification and technology conformance inspection. For device class M, screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection.

4.2.1 Additional criteria for device class M.

- a. Burn-in test, method 1015 of MIL-STD-883.
 - (1) Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in method 1015.
 - (2) $T_A = +125^{\circ}C$, minimum.
- b. Interim and final electrical test parameters shall be as specified in table II herein.
- c. For devices 02, 04, 06, and 08, all devices shall be mask programmed to the requirements of the altered item drawing prior to the initiation of any testing.
- 4.2.2 Additional criteria for device classes N, Q, and V.
 - a. The burn-in test duration, test condition and test temperature, or approved alternatives shall be as specified in the device manufacturer's QM plan in accordance with MIL-PRF-38535. The burn-in test circuit shall be maintained under document revision level control of the device manufacturer's Technology Review Board (TRB) in accordance with MIL-PRF-38535 and shall be made available to the acquiring or preparing activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in method 1015 of MIL-STD-883.
 - b. Interim and final electrical test parameters shall be as specified in table II herein.
 - c. Additional screening for device class V beyond the requirements of device class Q shall be as specified in MIL-PRF-38535, appendix B.

4.3 <u>Qualification inspection for device classes N, Q, and V</u>. Qualification inspection for device classes N, Q, and V shall be in accordance with MIL-PRF-38535. Inspections to be performed shall be those specified in MIL-PRF-38535 and herein for groups A, B, C, D, and E inspections (see 4.4.1 through 4.4.4).

4.4 <u>Conformance inspection</u>. Technology conformance inspection for classes N, Q, and V shall be in accordance with MIL-PRF-38535 including groups A, B, C, D, and E inspections and as specified herein. Quality conformance inspection for device class M shall be in accordance with MIL-PRF-38535, appendix A and as specified herein. Inspections to be performed for device class M shall be those specified in method 5005 of MIL-STD-883 and herein for groups A, B, C, D, and E inspections (see 4.4.1 through 4.4.4).

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4.4.1 Group A inspection.

- a. Tests shall be as specified in table II herein.
- b. Subgroups 5 and 6 in table I, method 5005 of MIL-STD-883 shall be omitted.
- c. Subgroup 4 (C_{IO}, measurement) shall be measured only for the initial test and after process or design changes which may affect input capacitance. A minimum sample size of 5 devices with zero rejects shall be required.
- d. For device class M, subgroups 7 and 8 tests shall be sufficient to verify the truth table. For device classes N, Q, and V, subgroups 7 and 8 shall include verifying the functionality of the device.

Test requirements	Subgroups (in accordance with MIL-STD-883, method 5005, table I)	Subgroups (in accordance with MIL-PRF-38535, table III)		
	Device	Device	Device	Device
	class M	class N	class Q	class V
Interim electrical				1,7,9
parameters (see 4.2)				
Final electrical	1, 2, 3, 7, 8,	1, 2, 3, 7, 8,	1, 2, 3, 7, 8,	1, 2, 3, 7, 8,
parameters (see 4.2)	9, 10, 11 <u>1</u> /	9, 10, 11 <u>1</u> /	9, 10, 11 <u>1</u> /	9, 10, 11 <u>2</u> /
Group A test	1, 2, 3, 4, 7, 8,	1, 2, 3, 4, 7, 8,	1, 2, 3, 4, 7, 8,	1, 2, 3, 4, 7, 8,
requirements (see 4.4)	9, 10, 11	9, 10, 11	9, 10, 11	9, 10, 11
Group C end-point electrical	2, 8A, 10	2, 8A, 10	2, 8A, 10	2, 8A, 10
parameters (see 4.4)				
Group D end-point electrical	2, 8A, 10	2, 8A, 10	2, 8A, 10	2, 8A, 10
parameters (see 4.4)				
Group E end-point electrical	1, 7, 9	1, 7, 9	1, 7, 9	1, 7, 9
parameters (see 4.4)				

TABLE II. Electrical test requirements.

1/ PDA applies to subgroup 1.

2/ PDA applies to subgroups 1 and 7.

4.4.2 <u>Group C inspection</u>. The group C inspection end-point electrical parameters shall be as specified in table II herein.

- 4.4.2.1 Additional criteria for device class M. Steady-state life test conditions, method 1005 of MIL-STD-883:
 - a. Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in method 1005 of MIL-STD-883.
 - b. $T_A = +125^{\circ}C$, minimum.
 - c. Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

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4.4.2.2 Additional criteria for device classes N, Q, and V. The steady-state life test duration, test condition and test temperature, or approved alternatives shall be as specified in the device manufacturer's QM plan in accordance with MIL-PRF-38535. The test circuit shall be maintained under document revision level control by the device manufacturer's TRB in accordance with MIL-PRF-38535 and shall be made available to the acquiring or preparing activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in method 1005 of MIL-STD-883.

4.4.3 Group D inspection. The group D inspection end-point electrical parameters shall be as specified in table II herein.

4.4.4 <u>Group E inspection</u>. Group E inspection is required only for parts intended to be marked as radiation hardness assured (see 3.5 herein).

- a. End-point electrical parameters shall be as specified in table II herein.
- b. For device classes N, Q, and V, the devices or test vehicle shall be subjected to radiation hardness assured tests as specified in MIL-PRF-38535 for the RHA level being tested. For device class M, the devices shall be subjected to radiation hardness assured tests as specified in MIL-PRF-38535, appendix A for the RHA level being tested. All device classes must meet the postirradiation end-point electrical parameter limits as defined in table I at T_A = +25°C ±5°C, after exposure, to the subgroups specified in table II herein.

5. PACKAGING

5.1 <u>Packaging requirements</u>. The requirements for packaging shall be in accordance with MIL-PRF-38535 for device classes N, Q, and V or MIL-PRF-38535, appendix A for device class M.

6. NOTES

6.1 <u>Intended use</u>. Microcircuits conforming to this drawing are intended for use for Government microcircuit applications (original equipment), design applications, and logistics purposes.

6.1.1 <u>Replaceability</u>. Microcircuits covered by this drawing will replace the same generic device covered by a contractor prepared specification or drawing.

6.1.2 Substitutability. Device class Q devices will replace device class M devices.

6.2 <u>Configuration control of SMD's</u>. All proposed changes to existing SMD's will be coordinated with the users of record for the individual documents. This coordination will be accomplished using DD Form 1692, Engineering Change Proposal.

6.3 <u>Record of users</u>. Military and industrial users should inform Defense Supply Center Columbus (DSCC) when a system application requires configuration control and which SMD's are applicable to that system. DSCC will maintain a record of users and this list will be used for coordination and distribution of changes to the drawings. Users of drawings covering microelectronic devices (FSC 5962) should contact DSCC-VA, telephone (614) 692-0544.

6.4 <u>Comments</u>. Comments on this drawing should be directed to DSCC-VA, Columbus, Ohio 43218-3990, or telephone (614) 692-0547.

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6.5 <u>Abbreviations, symbols, and definitions</u>. The abbreviations, symbols, and definitions used herein are defined in MIL-PRF-38535 and MIL-HDBK-1331 and as follows:

	Description			
<u>Pin symbol</u>	Description			
Port 0	Port 0 is an 8-bit open drain bidirect that state can be used as high-impe		pins that have 1's written to	them float, and in
	Port 0 is also the multiplexed low-or data memory. In this application it u the code bytes during program verifi during program verification.	ses strong internal p	ullups when emitting 1's. Po	ort 0 also outputs
Port 1	Port 1 is an 8-bit bidirectional I/O po pulled high by the internal pullups, a are externally being pulled low will s	nd in that state can b	be used as inputs. As inputs	s, port 1 pins that
	Port 1 also receives the low-order address bytes during program verification.			
Port 2	Port 2 is an 8-bit bidirectional I/O po pulled high by the internal pullups, a are externally being pulled low will s	nd in that state can b	be used as inputs. As inputs	s, port 2 pins that
	Port 2 emits the high-order address accesses to external data memory t uses strong internal pullups when en addresses (MOVX at Ri), port 2 emi	hat use 16-bit addres mitting 1's. During ad	sses (MOVX at DPTR). In the cesses to external data me	nis application it mory that used 8-bit
Port 3	Port 3 is an 8-bit bidirectional I/O port with internal pullups. Port 3 pins that have 1's written to them are pulled high by the internal pullups, and in that state can be used as inputs. As inputs, port 3 pins that are externally being pulled low will source current (I_{IL}), because of the pullups.			
	Port 3 also serves the functions of v	arious special feature	es of the MCS-51 family, as	listed below:
	Port pin Alternate 1	unction		
		al input port)		
		al output port)		
		ernal interrupt 0)		
	P3.3 INT1 (exte	rnal interrupt 1)		
	P3.4 T0 (timer () external input)		
	P3.5 T1 (timer	l external input)		
	P3.6 WR (exter	nal data memory writ	te strobe)	
	P3.7 RD (extern	nal data memory read	d strobe)	
RST	Reset input. A high on this pin for the An internal diffused resistor to $V_{\rm SS}$ p			
ALE	Address latch enable output pulse for latching the low byte of the address during accesses to external memory.			
	In normal operation, ALE is emitted at a constant rate of 1/6 the oscillator frequency, and may be used for external timing or clocking purposes. Note, however, that one ALE pulse is skipped during each access to external data memory.			
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6.5 <u>Abbreviations, symbols, and definitions</u> – Continued.

Pin symbol	Description
PSEN	Program store enable is the read strobe to external program memory. When the 02, 04, 06, and 08 devices are executing code from external program memory,PSEN is activated twice each machine cycle, except that two PSEN activations are skipped during each access to external data memory. PSEN is not activated during fetches from internal program memory.
ĒĀ	External access enable. EA must be externally held low in order to enable the device to fetch code from external program memory locations 0000H to 0FFFH. If EA is held high the device executes from internal program memory unless the program counter contains an address greater than 0FFFH.
XTAL1	Output from the inverting oscillator amplifier and input to the internal block generator circuits.
XTAL2	Output from the inverting oscillator amplifier.

6.6 Sources of supply.

6.6.1 <u>Sources of supply for device classes Q and V</u>. Sources of supply for device classes Q and V are listed in QML-38535. The vendors listed in QML-38535 have submitted a certificate of compliance (see 3.6 herein) to DSCC-VA and have agreed to this drawing.

6.6.2 <u>Approved sources of supply for device class M</u>. Approved sources of supply for class M are listed in MIL-HDBK-103. The vendors listed in MIL-HDBK-103 have agreed to this drawing and a certificate of compliance (see 3.6 herein) has been submitted to and accepted by DSCC-VA.

6.7 <u>PIN supersession information</u>. The PIN supersession data shall be as follows:

<u>NEW PIN</u>	OLD PIN
NEW PIN 5962-8506401MQX 5962-8506401MXX 5962-8506401MYX 5962-8506402MQX 5962-8506402MXX 5962-8506402MYX 5962-8506403MQX 5962-8506403MXX 5962-8506403MXX	OLD PIN 8506401QX 8506401XX 8506401YX 8506402QX 8506402XX 8506402YX 8506403QX 8506403XX 8506403XX
5962-8506404MQX 5962-8506404MXX 5962-8506404MXX 5962-8506404MYX	8506404QX 8506404XX 8506404YX

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STANDARD MICROCIRCUIT DRAWING BULLETIN

DATE: 07-11-26

Approved sources of supply for SMD 85064 are listed below for immediate acquisition information only and shall be added to MIL-HDBK-103 and QML-38535 during the next revision. MIL-HDBK-103 and QML-38535 will be revised to include the addition or deletion of sources. The vendors listed below have agreed to this drawing and a certificate of compliance has been submitted to and accepted by DSCC-VA. This information bulletin is superseded by the next dated revision of MIL-HDBK-103 and QML-38535. DSCC maintains an online database of all current sources of supply at http://www.dscc.dla.mil/Programs/Smcr/.

Standard Vendor Vendor microcircuit drawing CAGE similar PIN 1/ number PIN 2/ 5962-8506401MMA 0C7V7 80C31BH/BMA 5962-8506401MXA 0C7V7 80C31BH/BUA 5962-8506401MXA 0C7V7 80C31BH/CN40A 5962-8506401MYA 3/ 80C31BH/CN40A 5962-8506401NVA 3/ 80C31BH/CN40A 5962-8506402MMA 3/ 80C51BH 5962-8506402MQA 3/ 80C51BH/BQA 5962-8506402MQA 3/ 80C51BH/BQA 5962-8506402MXA 3/ 80C51BH/BQA 5962-8506402MXA 3/ 80C51BH/BQA 5962-8506402MXA 3/ 80C51BH/A 5962-8506402MXA 3/ 80C51BH/CA44A 5962-8506402NVA 3/ 80C51BH/CA44A 5962-8506403MMA 0C7V7 80C31BH-16/BMA 5962-8506403MXA 0C7V7 80C31BH-16/BUA 5962-8506403MXA 0C7V7 80C31BH-16/CN40A 5962-8506403MXA 0C7V7		1	
PIN 1/ number PIN 2/ 5962-8506401MMA 0C7V7 80C31BH/BMA 5962-8506401MQA 0C7V7 80C31BH/BQA 5962-8506401MXA 0C7V7 80C31BH/BUA 5962-8506401MYA 3/ 80C31BH/CN40A 5962-8506401NVA 3/ 80C31BH/CN40A 5962-8506401NVA 3/ 80C31BH/CN40A 5962-8506402MMA 3/ 80C51BH 5962-8506402MQA 3/ 80C51BH/BQA 5962-8506402MXA 3/ 80C51BH/BQA 5962-8506402MXA 3/ 80C51BH/BUA 5962-8506402MXA 3/ 80C51BH/BUA 5962-8506402MYA 3/ 80C51BH/A 5962-8506402MVA 3/ 80C51BH/CA44A 5962-8506402NVA 3/ 80C51BH/CA44A 5962-8506402NVA 3/ 80C51BH/CA44A 5962-8506403MMA 0C7V7 80C31BH-16/BMA 5962-8506403MXA 0C7V7 80C31BH-16/BUA 5962-8506403MXA 0C7V7 80C31BH-16/CN40A 5962-8506403MVA 3/	Standard	Vendor	Vendor
5962-8506401MMA 0C7V7 80C31BH/BMA 5962-8506401MQA 0C7V7 80C31BH/BQA 5962-8506401MXA 0C7V7 80C31BH/BUA 5962-8506401MYA 3/ 80C31BH/CN40A 5962-8506401NVA 3/ 80C31BH/CN40A 5962-8506401NVA 3/ 80C31BH/CN40A 5962-8506401NVA 3/ 80C31BH/CA44A 5962-8506402MMA 3/ 80C51BH 5962-8506402MQA 3/ 80C51BH/BUA 5962-8506402MXA 3/ 80C51BH/BUA 5962-8506402MXA 3/ 80C51BH/BUA 5962-8506402MXA 3/ 80C51BH/BUA 5962-8506402NVA 3/ 80C51BH/CA44A 5962-8506402NVA 3/ 80C51BH/CA44A 5962-8506402NVA 3/ 80C51BH/CA44A 5962-8506403NMA 0C7V7 80C31BH-16/BMA 5962-8506403MXA 0C7V7 80C31BH-16/BQA 5962-8506403MXA 0C7V7 80C31BH-16/BQA 5962-8506403MXA 0C7V7 80C31BH-16/CN40A 5962-8506403MVA 3/ 80C51B	microcircuit drawing	CAGE	
5962-8506401MQA 0C7V7 80C31BH/BQA 5962-8506401MXA 0C7V7 80C31BH/BUA 5962-8506401MYA 3/ 80C31BH/CN40A 5962-8506401NVA 3/ 80C31BH/CN40A 5962-8506401NVA 3/ 80C31BH/CN40A 5962-8506401NVA 3/ 80C31BH/CA44A 5962-8506402MQA 3/ 80C51BH 5962-8506402MQA 3/ 80C51BH/BQA 5962-8506402MXA 3/ 80C51BH/BUA 5962-8506402MXA 3/ 80C51BH/BUA 5962-8506402MXA 3/ 80C51BH/AA4A 5962-8506402NVA 3/ 80C51BH/CN40A 5962-8506402NVA 3/ 80C51BH/CN40A 5962-8506402NVA 3/ 80C51BH/AA 5962-8506403MQA 0C7V7 80C31BH-16/BQA 5962-8506403MXA 0C7V7 80C31BH-16/BQA 5962-8506403MXA 0C7V7 80C31BH-16/BQA 5962-8506403MXA 0C7V7 80C31BH-16/BQA 5962-8506403MXA 3/ 80C51BH-16/CN40A 5962-8506403MVA 3/ 80C51BH-	PIN <u>1</u> /	number	PIN <u>2</u> /
5962-8506401MXA 0C7V7 80C31BH/BUA 5962-8506401MYA 3/ 80C31BH/CN40A 5962-8506401NVA 3/ 80C31BH/CN40A 5962-8506401NVA 3/ 80C31BH/CA44A 5962-8506402MMA 3/ 80C51BH 5962-8506402MQA 3/ 80C51BH/BQA 5962-8506402MQA 3/ 80C51BH/BQA 5962-8506402MXA 3/ 80C51BH/BUA 5962-8506402MXA 3/ 80C51BH/BUA 5962-8506402MXA 3/ 80C51BH/BUA 5962-8506402MYA 3/ 80C51BH/CN40A 5962-8506402NVA 3/ 80C51BH/CN40A 5962-8506402NVA 3/ 80C51BH/CN40A 5962-8506402NVA 3/ 80C51BH/CA44A 5962-8506403MMA 0C7V7 80C31BH-16/BMA 5962-8506403MXA 0C7V7 80C31BH-16/BVA 5962-8506403MYA 3/ 80C51BH-16/CN40A 5962-8506403MVA 3/ 80C51BH-16/CN40A 5962-8506403NVA 3/ 80C51BH-16/CN40A 5962-8506404MMA 3/ 80C51BH-16/	5962-8506401MMA	0C7V7	80C31BH/BMA
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5962-8506401NUA 3/ 80C31BH/CN40A 5962-8506401NVA 3/ 80C31BH/CA44A 5962-8506402MMA 3/ 80C51BH 5962-8506402MQA 3/ 80C51BH/BQA 5962-8506402MXA 3/ 80C51BH/BQA 5962-8506402MXA 3/ 80C51BH/BUA 5962-8506402MXA 3/ 80C51BH/BUA 5962-8506402MYA 3/ 80C51BH/VA 5962-8506402MYA 3/ 80C51BH/CN40A 5962-8506402NVA 3/ 80C51BH/CN40A 5962-8506402NVA 3/ 80C51BH/CN40A 5962-8506402NVA 3/ 80C51BH/CA44A 5962-8506403MMA 0C7V7 80C31BH-16/BMA 5962-8506403MQA 0C7V7 80C31BH-16/BQA 5962-8506403MXA 0C7V7 80C31BH-16/BVA 5962-8506403MVA 3/ 80C51BH-16/BVA 5962-8506403NVA 3/ 80C51BH-16/CN40A 5962-8506403NVA 3/ 80C51BH-16/CN40A 5962-8506404MMA 3/ 80C51BH-16/BVA 5962-8506404MMA 3/ 80C51BH-16	5962-8506401MXA	0C7V7	80C31BH/BUA
5962-8506401NVA 3/ 80C31BH/CA44A 5962-8506402MMA 3/ 80C51BH 5962-8506402MQA 3/ 80C51BH/BQA 5962-8506402MXA 3/ 80C51BH/BQA 5962-8506402MXA 3/ 80C51BH/BUA 5962-8506402MXA 3/ 80C51BH/BUA 5962-8506402MXA 3/ 80C51BH/BVA 5962-8506402MYA 3/ 80C51BH/CN40A 5962-8506402NVA 3/ 80C51BH/CN40A 5962-8506402NVA 3/ 80C51BH/CN40A 5962-8506402NVA 3/ 80C51BH/CN40A 5962-8506403MMA 0C7V7 80C31BH-16/BMA 5962-8506403MQA 0C7V7 80C31BH-16/BUA 5962-8506403MXA 0C7V7 80C31BH-16/BVA 5962-8506403MVA 3/ 80C51BH-16/CN40A 5962-8506403NVA 3/ 80C51BH-16/CN40A 5962-8506403NVA 3/ 80C51BH-16/CN44A 5962-8506404MMA 3/ 80C51BH-16/BQA MD80C31BH-16 MB80C31BH-16 5962-8506404MXA 3/ 80C51BH-16/BVA	5962-8506401MYA	<u>3</u> /	80C31BH/BYA
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5962-8506402MQA 3/ 80C51BH/BQA 5962-8506402MXA 3/ 80C51BH/BUA 5962-8506402MXA 3/ 80C51BH/BUA 5962-8506402MYA 3/ 80C51BH/BVA 5962-8506402MYA 3/ 80C51BH/CN40A 5962-8506402NUA 3/ 80C51BH/CN40A 5962-8506402NVA 3/ 80C51BH/CA44A 5962-8506403MMA 0C7V7 80C31BH-16/BMA 5962-8506403MQA 0C7V7 80C31BH-16/BQA 5962-8506403MXA 0C7V7 80C31BH-16/BVA 5962-8506403MXA 0C7V7 80C31BH-16/BVA 5962-8506403MVA 3/ 80C51BH-16/BVA 5962-8506403NVA 3/ 80C51BH-16/CN40A 5962-8506403NVA 3/ 80C51BH-16/CN44A 5962-8506404MMA 3/ 80C51BH-16/BQA 5962-8506404MMA 3/ 80C51BH-16/BQA 65962-8506404MXA 3/ 80C51BH-16/BUA MR80C31BH-16 5962-8506404MXA 3/ 80C51BH-16/BVA 5962-8506404MXA 3/ 80C51BH-16/BVA 3/	5962-8506401NVA	<u>3</u> /	80C31BH/CA44A
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Image: Construct of the system Image: Construct of the system MR80C51BH 5962-8506402MYA 3/ 80C51BH/BYA 5962-8506402NUA 3/ 80C51BH/CA4AA 5962-8506402NVA 3/ 80C51BH/CA4AA 5962-8506402NVA 3/ 80C51BH/CA4AA 5962-8506403MMA 0C7V7 80C31BH-16/BMA 5962-8506403MQA 0C7V7 80C31BH-16/BQA 5962-8506403MXA 0C7V7 80C31BH-16/BUA 5962-8506403MXA 0C7V7 80C31BH-16/BVA 5962-8506403MYA 3/ 80C51BH-16/CN40A 5962-8506403NVA 3/ 80C51BH-16/CN40A 5962-8506403NVA 3/ 80C51BH-16/CN44A 5962-8506404MMA 3/ 80C51BH-16/BQA 5962-8506404MQA 3/ 80C51BH-16/BQA MR80C31BH-16 5962-8506404MXA 3/ 5962-8506404MXA 3/ 80C51BH-16/BUA MR80C31BH-16 5962-8506404MXA 3/ 5962-8506404MYA 3/ 80C51BH-16/BVA 5962-8506404MYA 3/ 80C51BH-16/BVA			MD80C51BH
5962-8506402MYA 3/ 80C51BH/BYA 5962-8506402NUA 3/ 80C51BH/CN40A 5962-8506402NVA 3/ 80C51BH/CA44A 5962-8506403MMA 0C7V7 80C31BH-16/BMA 5962-8506403MQA 0C7V7 80C31BH-16/BQA 5962-8506403MXA 0C7V7 80C31BH-16/BQA 5962-8506403MXA 0C7V7 80C31BH-16/BUA 5962-8506403MXA 0C7V7 80C31BH-16/BVA 5962-8506403MVA 3/ 80C51BH-16/CN40A 5962-8506403NVA 3/ 80C31BH-16/CN40A 5962-8506403NVA 3/ 80C51BH-16/CN40A 5962-8506404MMA 3/ 80C51BH-16/BQA 5962-8506404MXA 3/ 80C51BH-16/BQA 5962-8506404MXA 3/ 80C51BH-16/BUA 5962-8506404MXA 3/ 80C51BH-16/BUA 5962-8506404MXA 3/ 80C51BH-16/BUA 5962-8506404MYA 3/ 80C51BH-16/BUA 5962-8506404MYA 3/ 80C51BH-16/BVA 5962-8506404MYA 3/ 80C51BH-16/BVA	5962-8506402MXA	<u>3</u> /	80C51BH/BUA
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5962-8506403NVA 3/ 80C31BH-16/CN44A 5962-8506404MMA 3/ 80C51BH-16 5962-8506404MQA 3/ 80C51BH-16/BQA 5962-8506404MQA 3/ 80C51BH-16/BQA 5962-8506404MQA 3/ 80C51BH-16/BQA 5962-8506404MXA 3/ 80C51BH-16/BUA 5962-8506404MXA 3/ 80C51BH-16/BUA 5962-8506404MYA 3/ 80C51BH-16/BYA 5962-8506404NUA 3/ 80C51BH-16/CN40A	5962-8506403MYA	<u>3</u> /	80C51BH-16/BYA
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5962-8506404MQA 3/ 80C51BH-16/BQA 5962-8506404MXA 3/ 80C51BH-16/BUA 5962-8506404MXA 3/ 80C51BH-16/BUA 5962-8506404MYA 3/ 80C51BH-16/BVA 5962-8506404MYA 3/ 80C51BH-16/BYA 5962-8506404NUA 3/ 80C51BH-16/CN40A	5962-8506403NVA	<u>3</u> /	80C31BH-16/CN44A
MD80C31BH-16 5962-8506404MXA <u>3</u> / 80C51BH-16/BUA MR80C31BH-16 MR80C31BH-16 5962-8506404MYA <u>3</u> / 80C51BH-16/BYA 5962-8506404NUA <u>3</u> / 80C51BH-16/CN40A	5962-8506404MMA	<u>3</u> /	80C51BH-16
5962-8506404MXA 3/ 80C51BH-16/BUA MR80C31BH-16 MR80C31BH-16 5962-8506404MYA 3/ 80C51BH-16/BYA 5962-8506404NUA 3/ 80C51BH-16/CN40A	5962-8506404MQA	<u>3</u> /	80C51BH-16/BQA
MR80C31BH-16 5962-8506404MYA <u>3</u> / 80C51BH-16/BYA 5962-8506404NUA <u>3</u> / 80C51BH-16/CN40A			MD80C31BH-16
5962-8506404MYA 3/ 80C51BH-16/BYA 5962-8506404NUA 3/ 80C51BH-16/CN40A	5962-8506404MXA	<u>3</u> /	80C51BH-16/BUA
5962-8506404NUA <u>3</u> / 80C51BH-16/CN40A			MR80C31BH-16
	5962-8506404MYA	<u>3</u> /	80C51BH-16/BYA
5962-8506404NVA <u>3</u> / 80C51BH-16/CN44A	5962-8506404NUA	<u>3</u> /	80C51BH-16/CN40A
	5962-8506404NVA	<u>3</u> /	80C51BH-16/CN44A

See footnotes at end of table.

STANDARD MICROCIRCUIT DRAWING BULLETIN - Continued.

DATE: 07-11-26

Standard microcircuit drawing	Vendor CAGE	Vendor similar
PIN <u>1</u> /	number	PIN <u>2</u> /
5962-8506405NUA	<u>3</u> /	80C31BH/IN40A
5962-8506405NVA	<u>3</u> /	80C31BH/IA44A
5962-8506406NUA	<u>3</u> /	80C51BH/IN40A
5962-8506406NVA	<u>3</u> /	80C51BH/IA44A
5962-8506407NUA	<u>3</u> /	80C31BH-16/IN40A
5962-8506407NVA	<u>3</u> /	80C31BH-16/IA44A
5962-8506408NUA	<u>3</u> /	80C51BH-16/IN40A
5962-8506408NVA	<u>3</u> /	80C51BH-16/IA44A

- <u>1</u>/ The lead finish shown for each PIN representing a hermetic package is the most readily available from the manufacturer listed for that part. If the desired lead finish is not listed contact the vendor to determine its availability.
- 2/ <u>Caution</u>. Do not use this number for item acquisition. Items acquired to this number may not satisfy the performance requirements of this drawing.
- 3/ Not available from an approved source of supply.

Vendor CAGE <u>number</u> Vendor name and address

0C7V7

QP Semiconductor 2945 Oakmead Village Court Santa Clara, CA 95051

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